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Diodes Incorporated DMC4047LSD-13

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Datasheet of DMC4047LSD-13 - MOSFET N/P-CH 40V 7A/5.1A 8SOIC

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DMC4047LSD

#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

#### **Product Summary**

Device	V <sub>(BR)DSS</sub>	R <sub>DS(on) max</sub>	I <sub>D</sub> T <sub>A</sub> = +25°C	
Q2	40V	24mΩ @ V <sub>GS</sub> = 10V	6.9A	
QZ	400	$32m\Omega$ @ $V_{GS}$ = $4.5V$	6.0A	
Q1	-40V	45mΩ @ V <sub>GS</sub> = -10V	-5.1A	
QI	- <del>4</del> 0V	55mΩ @ V <sub>GS</sub> = -4.5V	-4.5A	

#### **Features and Benefits**

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Description**

This new generation MOSFET has been designed to minimize the onstate resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Mechanical Data**

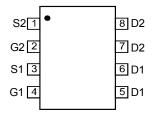
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.074 grams (approximate)

#### **Applications**

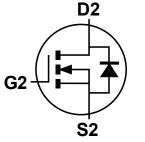
- DC-DC Converters
- **Power Management Functions**
- Backlighting



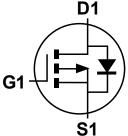
Top View



TOP VIEW Internal Schematic



N-Channel MOSEET



P-Channel MOSFET

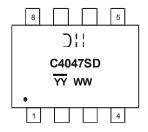
### Ordering Information (Note 4)

Part Number	Case	Packaging
DMC4047LSD-13	SO-8	2,500/Tape & Reel

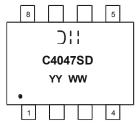
Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>
  4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

#### Marking Information



Chengdu A/T Site



Shanghai A/T Site

D¦¦ = Manufacturer's Marking C4047SD = Product Type Marking Code YYWW<u>=</u> Date Code Marking YY or YY = Year (ex: 13 = 2013) WW = Week (01 - 53)

YY = Date Code Marking for SAT (Shanghai Assembly/ Test site) YY = Date Code Marking for CAT (Chengdu Assembly/ Test site)

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### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value_Q2	Value_Q1	Units			
Drain-Source Voltage	V <sub>DSS</sub>	40	-40	V			
Gate-Source Voltage	V <sub>GSS</sub>	±20	±20	V			
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	7.0 5.6	-5.1 -4.1	А	
Continuous Diain Current (Note 6) VGS - 10V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	9.0 7.2	-6.5 -5.2	Α	
Maximum Body Diode Forward Current (Note 6)	I <sub>S</sub>	2.5	-2.5	Α			
Pulsed Drain Current (10µs pulse, duty cycle = 1	I <sub>DM</sub>	70	-40	Α			
Avalanche Current (Notes 7) L = 0.1mH	I <sub>AR</sub>	20	20	Α			
Repetitive Avalanche Energy (Notes 7) L = 0.1m	E <sub>AR</sub>	20	20	mJ			

#### Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	1.3	W
Total Fower Dissipation (Note 5)	T <sub>A</sub> = +70°C	PD	0.8	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	В	98	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{ hetaJA}$	59	
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	1.8	W
Total Fower Dissipation (Note o)	T <sub>A</sub> = +70°C	PD	1.1	
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	D	71	°C/W
Thermal Resistance, Junction to Ambient (Note 0)	t<10s	$R_{ hetaJA}$	43	
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	11.8	
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

#### Electrical Characteristics N-Channel Q2 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)			- 76			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	40	_	_	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μA	V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)				•	•	
Gate Threshold Voltage	V <sub>GS(th)</sub>	1.4	_	2.4	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance	D		15	24	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 6A
Static Diain-Source On-Resistance	R <sub>DS(ON)</sub>	_	20	32	11122	$V_{GS} = 4.5V, I_D = 5A$
Diode Forward Voltage	V <sub>SD</sub>		0.7	1.0	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1.0A
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C <sub>iss</sub>		1060	_		V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, f = 1.0MHz
Output Capacitance	Coss	_	84	_	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	58	_		
Gate Resistance	R <sub>G</sub>	_	1.6	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg		8.8	_		V <sub>DS</sub> = 20V, I <sub>D</sub> = 8A
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg		19.1	_	nC	
Gate-Source Charge	Qgs		3.0	_	IIC	
Gate-Drain Charge	$Q_{gd}$		2.5	_		
Turn-On Delay Time	t <sub>D(on)</sub>		5.3	_		$V_{DD} = 25V, R_{L} = 2.5\Omega$
Turn-On Rise Time	t <sub>r</sub>	_	7.1	_	nS	
Turn-Off Delay Time	t <sub>D(off)</sub>		15.1	_	1115	$V_{GS}$ = 10V, $R_G$ = 3 $\Omega$
Turn-Off Fall Time	t <sub>f</sub>		4.8	_	1	
Body Diode Reverse Recovery Time	t <sub>rr</sub>		10.5	_	nS	I <sub>F</sub> = 8A, di/dt = 100A/μs
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>		4.15	_	nC	I <sub>F</sub> = 8A, di/dt = 100A/μs

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#### Electrical Characteristics P-Channel Q1 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-40		_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_		-1	μA	V <sub>DS</sub> = -40V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	_		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	-1.0		-2.2	٧	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Otatia Dania Carras On Basistana	J	_	33	45	0	$V_{GS} = -10V, I_D = -5A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	40	55	mΩ	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -4A
Diode Forward Voltage	$V_{SD}$	_	-0.7	-1.0	V	$V_{GS} = 0V, I_S = -1.0A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	_	1154	_		V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V f = 1.0MHz
Output Capacitance	Coss	_	84	—	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	66	_		
Gate Resistance	R <sub>G</sub>	_	12.6	_	Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1.0MHz
Total Gate Charge (V <sub>GS</sub> = -4.5V)	$Q_g$	_	10.6	—		V 20V h 40A
Total Gate Charge (V <sub>GS</sub> = -10V)	$Q_g$	_	21.5	—	<b>~</b> C	
Gate-Source Charge	Qgs	_	2.2	_	nC	V <sub>DS</sub> = -20V, I <sub>D</sub> = -4.9A
Gate-Drain Charge	$Q_{gd}$	_	3.3	_		
Turn-On Delay Time	t <sub>D(on)</sub>	_	8.7	_		
Turn-On Rise Time	tr	_	19.6	_		VDS = -20V, ID = -3.9A
Turn-Off Delay Time	t <sub>D(off)</sub>	_	34.9	_	nS	$V_{GS} = -4.5V$ , $R_{G} = 1\Omega$
Turn-Off Fall Time	t <sub>f</sub>	_	25.5	_		
Body Diode Reverse Recovery Time	t <sub>rr</sub>	_	9.61	_	nS	I <sub>S</sub> = -3.9A, dI/dt = 100A/μs
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	_	3.30	_	nC	I <sub>S</sub> = -3.9A, dI/dt = 100A/μs

Notes:

- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
   Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
   IAR and EAR rating are based on low frequency and duty cycles to keep TJ = +25°C

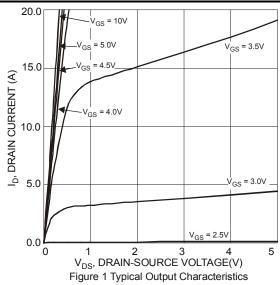
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.

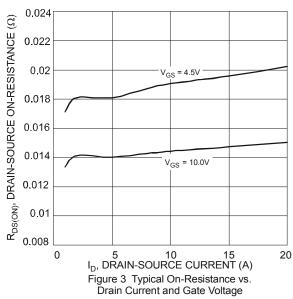
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#### N-Channel Q2





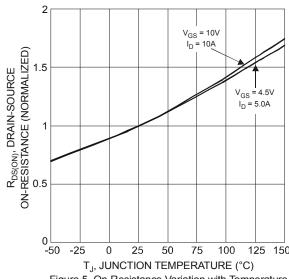
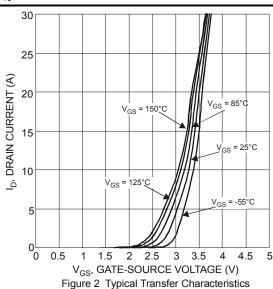


Figure 5 On-Resistance Variation with Temperature



0.05 DRAIN-SOURCE ON-RESISTANCE (\Overline{\Omega}) 0.045 0.04 T<sub>A</sub>= 150°C 0.035 T<sub>A</sub>= 125°C 0.03 T<sub>^</sub>= 85°C 0.025 T<sub>A</sub>= 25°C 0.02 0.015 0.01 0.005 0.005 0.01 0 0 15 20 25 30 I<sub>D</sub>, DRAIN CURRENT(A) Figure 4 Typical On-Resistance vs. Drain Current and Temperature

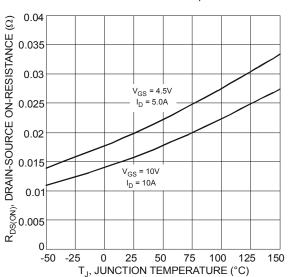


Figure 6 On-Resistance Variation with Temperature

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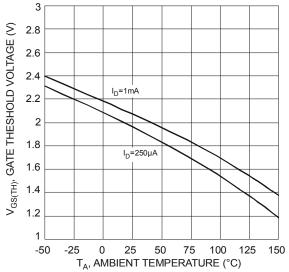
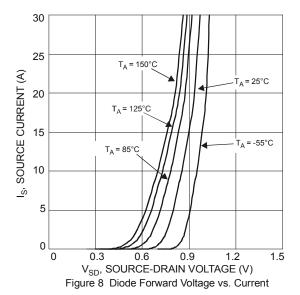


Figure 7 Gate Theshold Variation vs Ambient Temperature



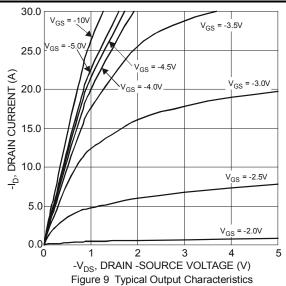
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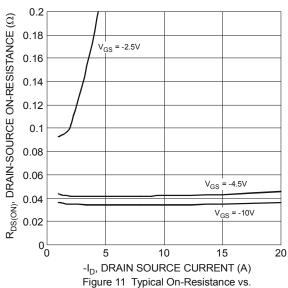
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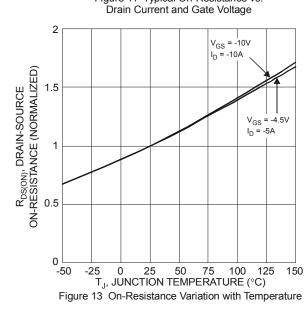


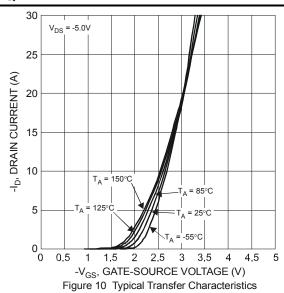
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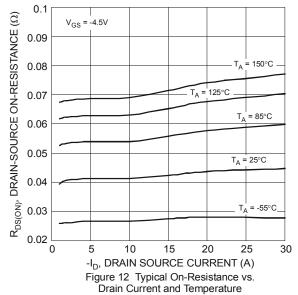
#### P-Channel Q1











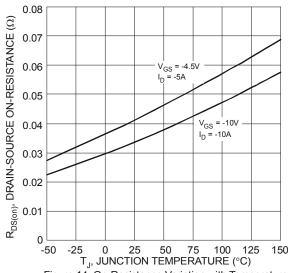


Figure 14 On-Resistance Variation with Temperature

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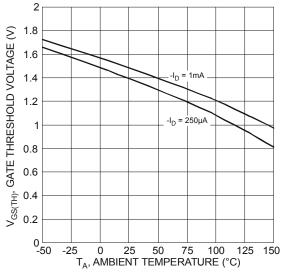
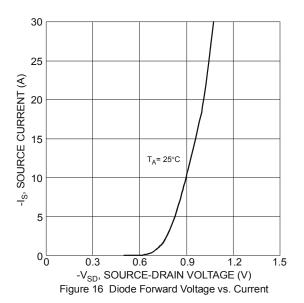
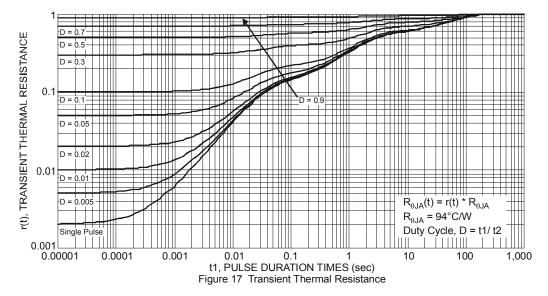


Figure 15 Gate Threshold Variation vs. Ambient Temperature





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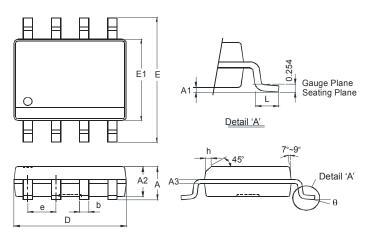
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#### **Package Outline Dimensions**

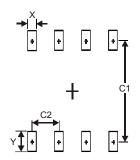
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SO-8					
Dim	Min	Max				
Α	-	1.75				
A1	0.10	0.20				
A2	1.30	1.50				
A3	0.15	0.25				
b	0.3	0.5				
D	4.85	4.95				
Е	5.90	6.10				
E1	3.85	3.95				
е	1.27 Typ					
h	1	0.35				
L	0.62	0.82				
θ	0°	8°				
All Di	All Dimensions in mm					

### **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.60
Υ	1.55
C1	5.4
C2	1.27



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